

## Harvatek Surface Mount CHIP LEDs Data Sheet T4331IR--20C6401L2U1930

Official Product	HT Part No.T4331IR--20C6401L2U1930		
Tentative Product	*****	*****	*****
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## Product Specifications

Item	Specification	Material	Quantity
Peak Wavelength $\lambda_p$	Typ:940 nm @20mA/ $T_s= 25^\circ\text{C}$ ;Tolerance: $\pm 1\text{nm}$		
Radiant Intensity $I_e$	Typ:17 mW/sr @20mA/ $T_s= 25^\circ\text{C}$ ;Tolerance: $\pm 10\%$		
Forward Voltage $V_F$	Typ:1.3 V @20mA/ $T_s= 25^\circ\text{C}$ ;Tolerance: $\pm 0.1\text{V}$		
Reverse Current $I_R$	< 10 $\mu\text{A}$ @ $V_R = 5\text{ V}$		
Resin	Clear	Epoxy	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

**Others:**

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of  $I_v$ ,  $\lambda_D$  and  $V_f$ . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

**ATTENTION: Electrostatic Discharge (ESD) protection**

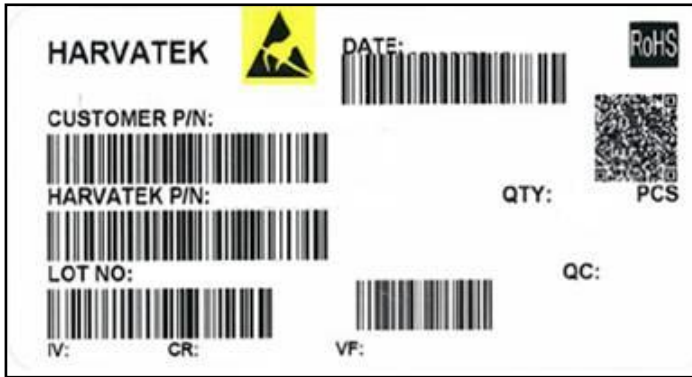


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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## Label Specifications



### ■Harvatek P/N:

**T            433            1            IR--            20C-            6401            L2**

Product	Package	Dice Q'ty	Color	Current	Series Number	Taping
PCB	4.2(L)x3.3(W)x3.6(H) mm	1:Single	IR:940nm	20mA	X001~XZZZ	1.Taping style 2. Q'ty

### ■ Lot No.:

1	2	3	4	5	6	7	8	9	10
<b>E</b>	<b>1</b>	<b>A</b>	<b>1</b>	<b>A</b>	<b>2</b>	<b>2</b>	<b>L</b>	<b>1</b>	<b>2</b>
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2020-L		1:A	01~ZZ		000~ZZZ		
		2021-M		2:B					
		2022-P		3:C					
		2023-Q	1:Jan.	...					
		...	2:Feb.	...					
		2026-T	...	26:Z					
		2027-V	A:Oct.	27:7					
		...	B:Nov.	28:8					
		2030-Y	C:Dec.	29:9					
		2031-Z		30:3					
...		31:4							

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### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
$I_F$	Forward Current	100	mA	
$I_{FP}$	Peak Forward Current	1	A	1
$V_R$	Reverse Voltage	5	V	
$T_{opr}$	Operating Temperature	-40 ~ +85	°C	
$T_{stg}$	Storage Temperature	-40 ~ +100	°C	
$T_{sol}$	Soldering Temperature	260	°C	2

### Notes:

- 1  $I_{FP}$  Conditions--Pulse Width  $\leq 100\mu s$  and Duty  $\leq 1\%$ .
- 2 Soldering time  $\leq 5$  seconds.

### Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Typ	Max	Units	Notes
$I_e$	Radiant Intensity	$I_F=20mA$	-	17	-	mW/sr	3
$\lambda_P$	Peak Wavelength	$I_F=20mA$	930	940	960	nm	
$\Delta\lambda$	Spectral bandwidth at 50% of $I_{max}$	$I_F=20mA$	-	30	-	nm	
$V_F$	Forward Voltage	$I_F=20mA$	-	1.3	1.6-	V	
$I_R$	Reverse Current	$V_R=5V$	-	-	10	$\mu A$	
$2\theta_{1/2}$	Angle of Half Intensity (X)	$I_F=20mA$	-	70	-	deg	
	Angle of Half Intensity (Y)		-	16	-		

### Notes:

- 3 Radiant Intensity ( $I_e$ ) Bin:

Color	Bin Code	Spec. Range
IR	L-3	15-17 mW/sr
	M-4	17-21 mW/sr
	N-5	21-25 mW/sr
	P-6	25-27 mW/sr

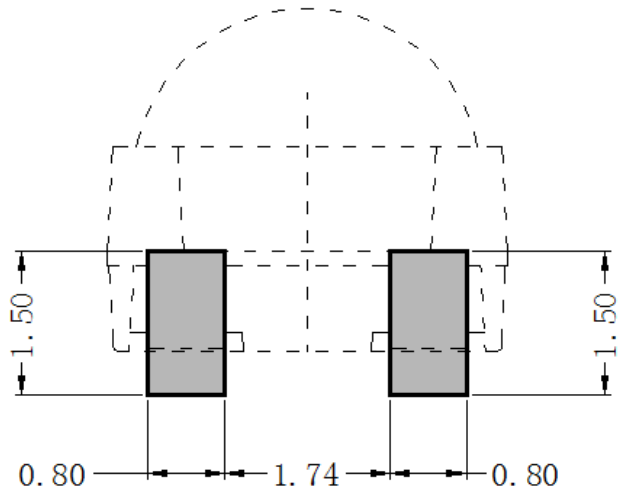
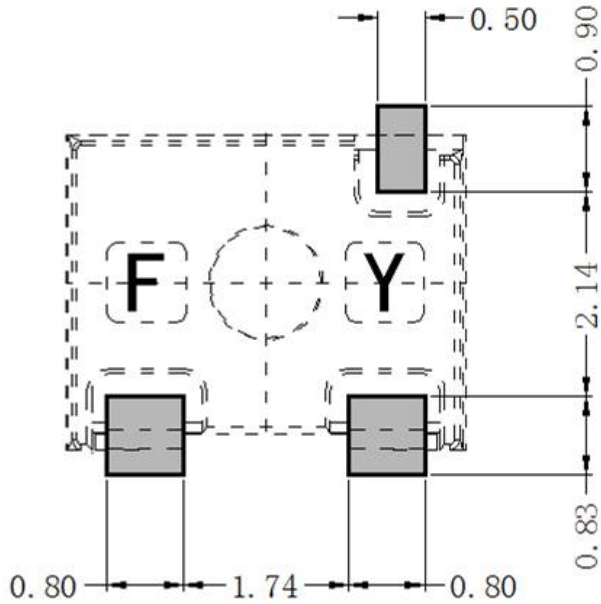
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## Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)

Outline Dim.	Soldering Pattern
<p>① Anode ② Cathode</p>	<p>open</p>
<p>Soldering terminals may shift in the Wd direction.</p>	

### Solder recommendations



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Characteristics of T4331	
Spectral Distribution	Forward Current vs. Ambient Temperature
Peak Emission Wavelength vs. Ambient Temperature	Forward Current vs. Forward Voltage
Radiant Intensity vs. Forward Current	Relative Radiant Intensity vs. Angular Displacement

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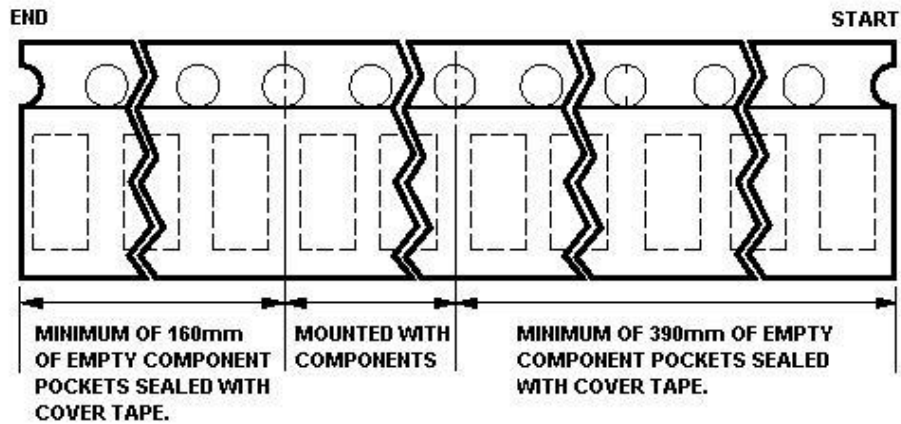
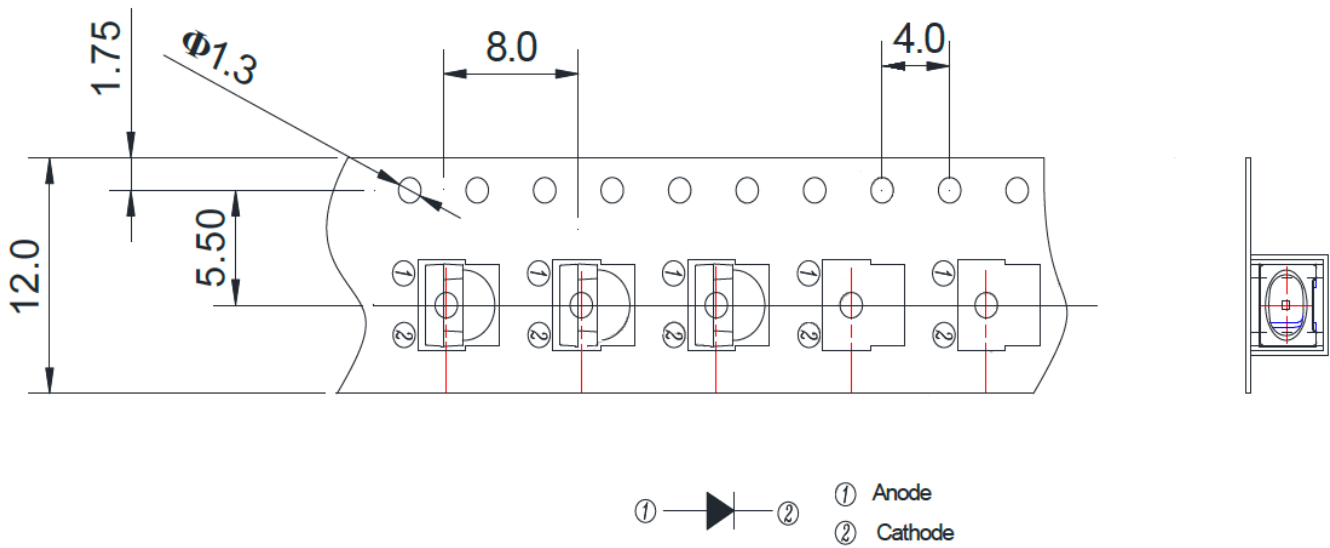


## Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 24 hours after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

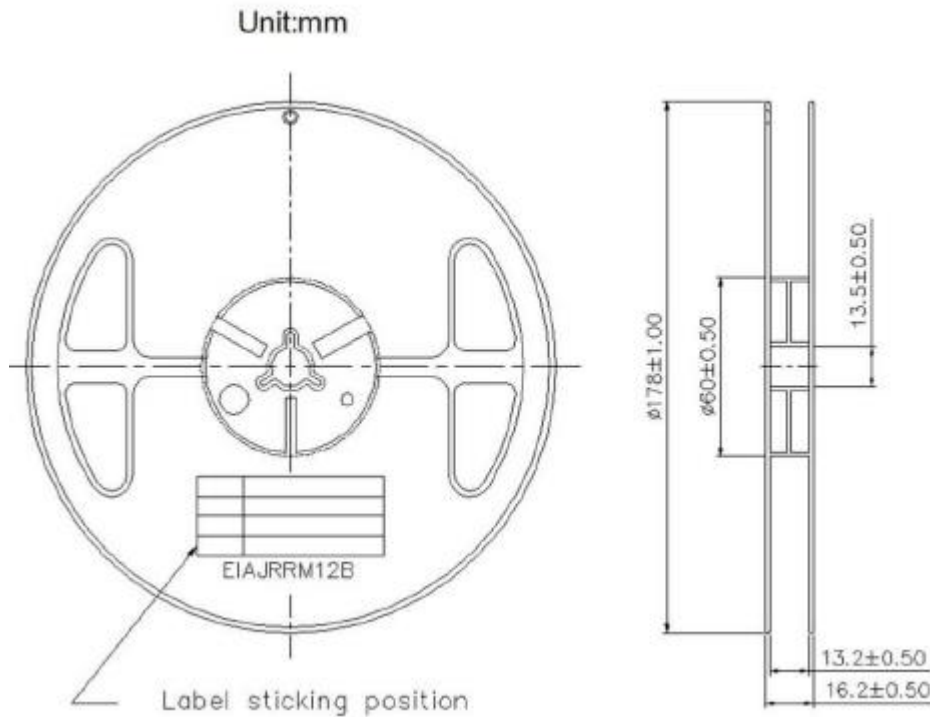
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**Packaging**  
**Tape Dimension**



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## Reel Dimension



## Packing

1. 2000 Pcs/1 Tape, 2 Tape/1 Moisture-proof Bags
2. 10 Moisture-proof Bags / 1 Outside Carton

## Baking

Baking before soldering is recommended when the package has been unsealed for 24 hours. The conditions are as followings:

1.  $60 \pm 3^\circ\text{C} \times (12 \sim 24 \text{hrs})$  and  $< 5\% \text{RH}$ , taped reel type.
2.  $100 \pm 3^\circ\text{C} \times (45 \text{min} \sim 1 \text{hr})$ , bulk type.
3.  $130 \pm 3^\circ\text{C} \times (15 \text{min} \sim 30 \text{min})$ , bulk type.

## Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

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**Handling of Silicone Resin LEDs**

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible.

Sharp objects of all types should not be used to pierce the sealing compound.



Figure 1

In general, LEDs should only be handled from the side. By the way ,this also applies to LEDs without a silicone sealant, since the surface can also become scratched.

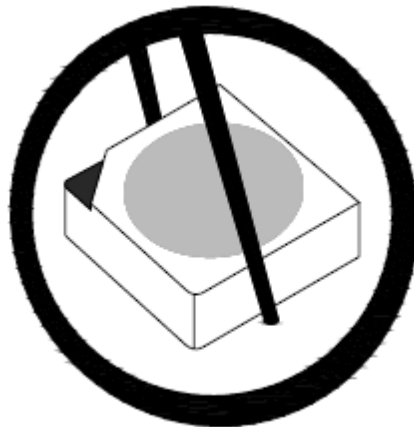


Figure 2

When populating boards in SMT production, there are basically no restrictions regarding the from of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

This is assured by choosing a pick and place nozzle which is large than LEDs reflector area.

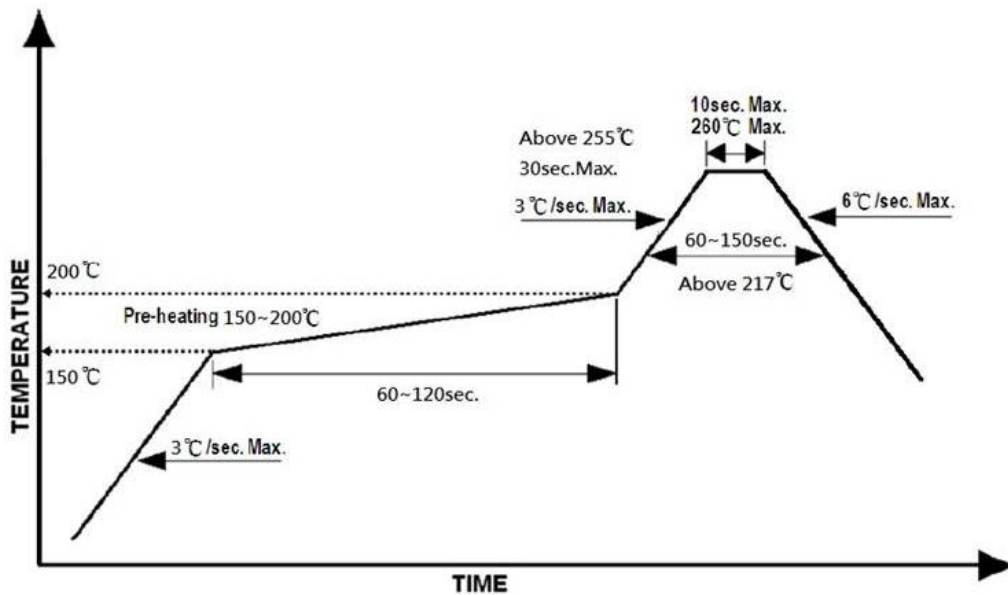
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## Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217 °C ,60~150 sec.
2. Peak temp.:260 °CMax.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

### Lead-free Solder Profile



## Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

## Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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